

NCE N-Channel Super Junction Power MOSFET (With Fast Body Diode)

General Description

The series of devices use advanced super junction technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. This super junction MOSFET fits the industry's AC-DC SMPS requirements for PFC, AC/DC power conversion, and industrial power applications.

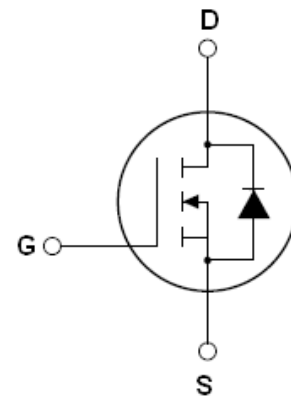
Features

- New technology for high voltage device
- Low on-resistance and low conduction losses
- Intrinsic fast-recovery body diode
- Extreme low reverse recovery charge
- 100% Avalanche Tested

Application

- Power factor correction (PFC)
- Switched mode power supplies(SMPS)
- Uninterruptible Power Supply (UPS)
- strongly recommended for bridge topologies

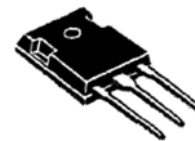
V_{DS}	650	V
$R_{DS(ON)}$	210	m Ω
I_D	20	A



Schematic diagram

Package Marking And Ordering Information

Device	Device Package	Marking
NCE20NF65T	TO-247	NCE20NF65T



TO-247

Table 1. Absolute Maximum Ratings ($T_C=25^\circ\text{C}$)

Parameter	Symbol	NCE20NF65T	Unit
Drain-Source Voltage ($V_{GS}=0V$)	V_{DS}	650	V
Gate-Source Voltage ($V_{DS}=0V$)	V_{GS}	± 30	V
Continuous Drain Current at $T_C=25^\circ\text{C}$	$I_{D(DC)}$	20	A
Continuous Drain Current at $T_C=100^\circ\text{C}$	$I_{D(DC)}$	12.5	A
Pulsed drain current (Note 1)	$I_{DM(pluse)}$	60	A
Drain Source voltage slope, $V_{DS} = 480\text{ V}$, $I_D = 20\text{ A}$, $T_J = 125^\circ\text{C}$	dv/dt	50	V/ns
Maximum Power Dissipation($T_C=25^\circ\text{C}$)	P_D	208	W
Derate above 25°C		1.67	W/ $^\circ\text{C}$
Single pulse avalanche energy (Note 2)	E_{AS}	690	mJ
Avalanche current (Note 1)	I_{AR}	20	A
Repetitive Avalanche energy, t_{AR} limited by T_{Jmax} (Note 1)	E_{AR}	1	mJ
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55...+150	$^\circ\text{C}$

* limited by maximum junction temperature

Table 2. Thermal Characteristic

Parameter	Symbol	NCE20NF65T	Unit
Thermal Resistance, Junction-to-Case (Maximum)	R_{thJC}	0.6	$^{\circ}\text{C}/\text{W}$
Thermal Resistance, Junction-to-Ambient (Maximum)	R_{thJA}	62	$^{\circ}\text{C}/\text{W}$

Table 3. Electrical Characteristics (TA=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit	
On/off states							
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=250\mu A$	650			V	
Zero Gate Voltage Drain Current(Tc=25°C)	I_{DSS}	$V_{DS}=650V, V_{GS}=0V$			1	μA	
Zero Gate Voltage Drain Current(Tc=125°C)	I_{DSS}	$V_{DS}=650V, V_{GS}=0V$			100	μA	
Gate-Body Leakage Current	I_{GSS}	$V_{GS}=\pm 30V, V_{DS}=0V$			± 100	nA	
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	3		5	V	
Drain-Source On-State Resistance	$R_{DS(ON)}$	$V_{GS}=10V, I_D=10A$		180	210	m Ω	
Dynamic Characteristics							
Forward Transconductance	g_{FS}	$V_{DS} = 20V, I_D = 10A$		17.5		S	
Input Capacitance	C_{ISS}	$V_{DS}=50V, V_{GS}=0V,$ $F=1.0MHz$		2400		pF	
Output Capacitance	C_{OSS}			180		pF	
Reverse Transfer Capacitance	C_{RSS}			5.7		pF	
Total Gate Charge	Q_g	$V_{DS}=480V, I_D=20A,$ $V_{GS}=10V$		55	114	nC	
Gate-Source Charge	Q_{gs}			11		nC	
Gate-Drain Charge	Q_{gd}			22		nC	
Intrinsic gate resistance	R_G	$f = 1 \text{ MHz open drain}$		0.9		Ω	
Switching times							
Turn-on Delay Time	$t_{d(on)}$	$V_{DD}=380V, I_D=20A,$ $R_G=3.6\Omega, V_{GS}=10V$		10		nS	
Turn-on Rise Time	t_r			5		nS	
Turn-Off Delay Time	$t_{d(off)}$			50	100	nS	
Turn-Off Fall Time	t_f			5	12	nS	
Source- Drain Diode Characteristics							
Source-drain current(Body Diode)	I_{SD}	$T_C=25^{\circ}\text{C}$			20	A	
Pulsed Source-drain current(Body Diode)	I_{SDM}				60	A	
Forward on voltage	V_{SD}	$T_j=25^{\circ}\text{C}, I_{SD}=20A, V_{GS}=0V$		0.9	1.3	V	
Reverse Recovery Time	t_{rr}	$T_j=25^{\circ}\text{C}, I_F=20A, di/dt=100A/\mu s$		190		nS	
Reverse Recovery Charge	Q_{rr}				1.5		μC
Peak reverse recovery current	I_{rrm}				13		A

Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature

2. $T_j=25^{\circ}\text{C}, V_{DD}=50V, V_G=10V, R_G=25\Omega$

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (curves)

Figure1. Safe operating area for NCE20NF65T

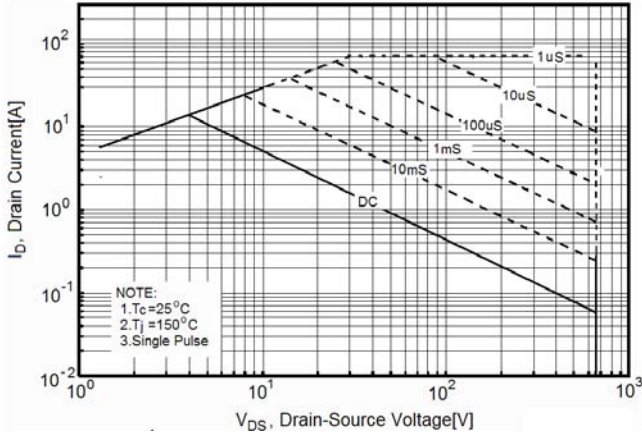


Figure2. Source-Drain Diode Forward Voltage

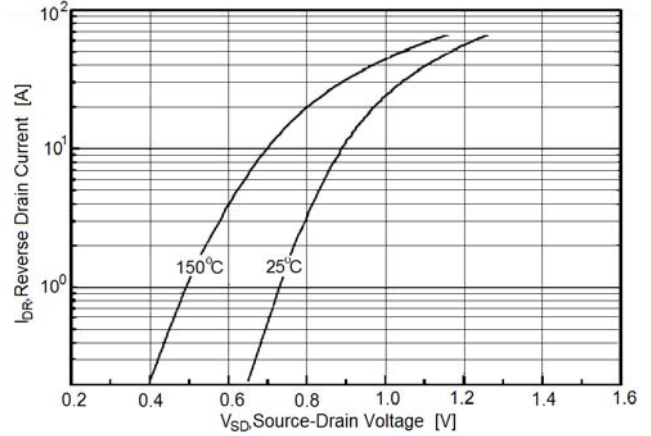


Figure3. Output characteristics

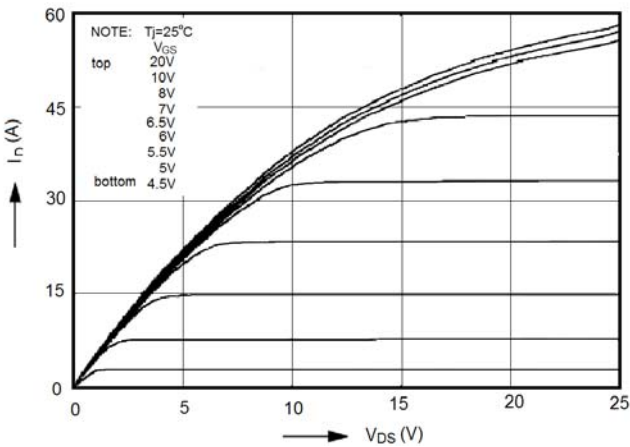


Figure4. Transfer characteristics

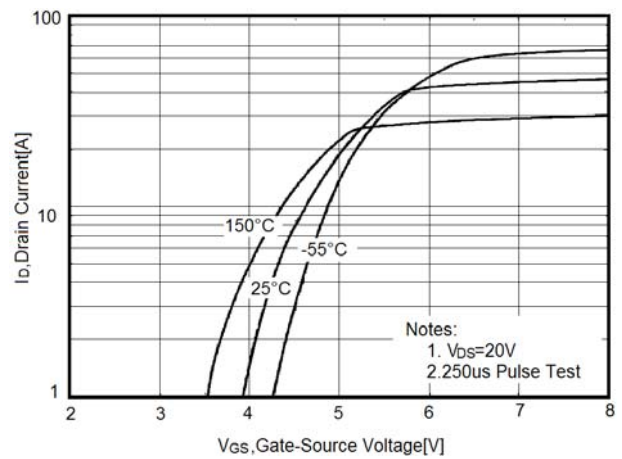


Figure5. Static drain-source on resistance

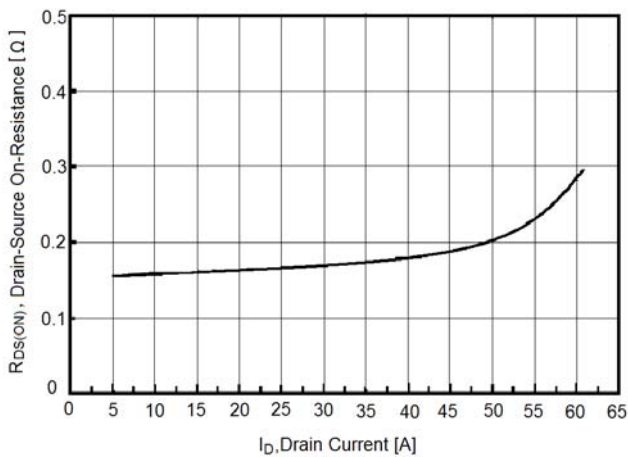


Figure6. R_DS(ON) vs Junction Temperature

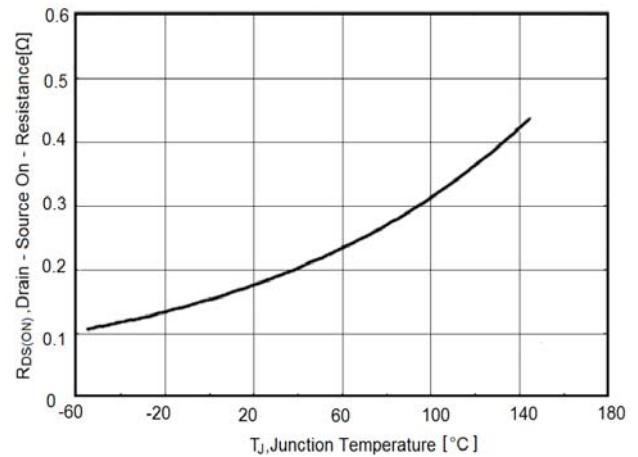


Figure7. BV_{DSS} vs Junction Temperature

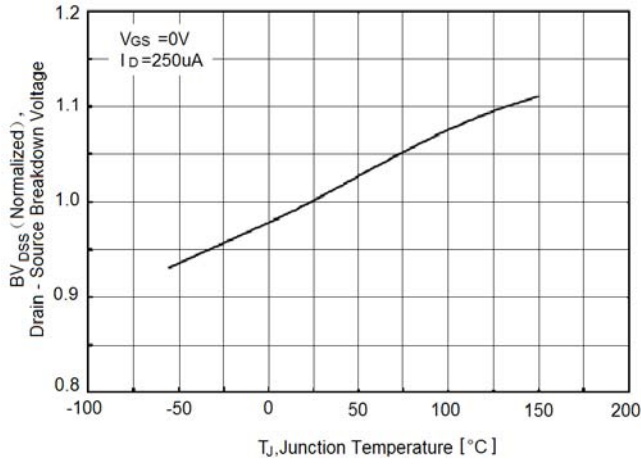


Figure8. Maximum I_D vs Junction Temperature

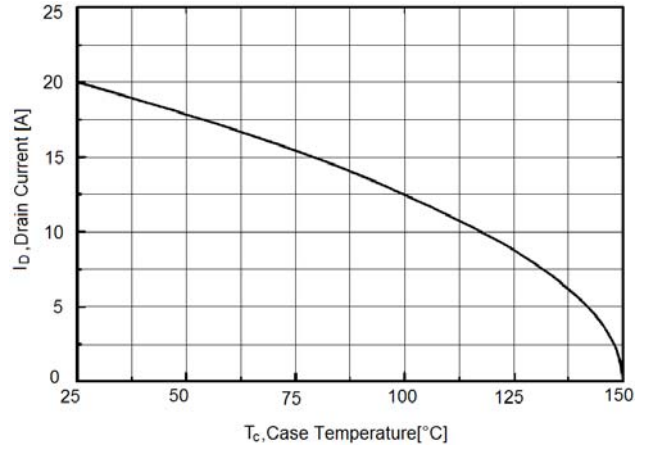


Figure9. Gate charge waveforms

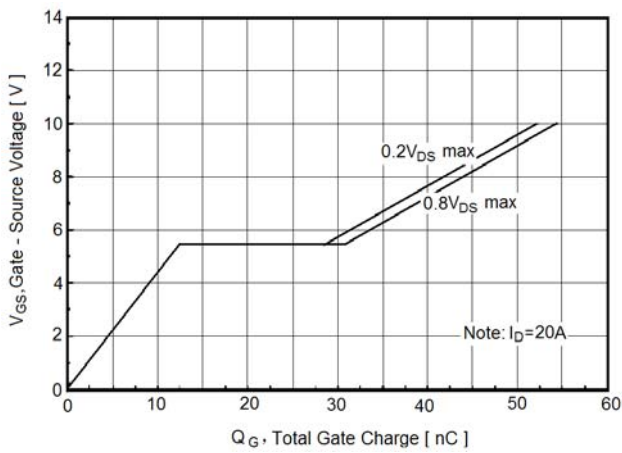


Figure10. Capacitance

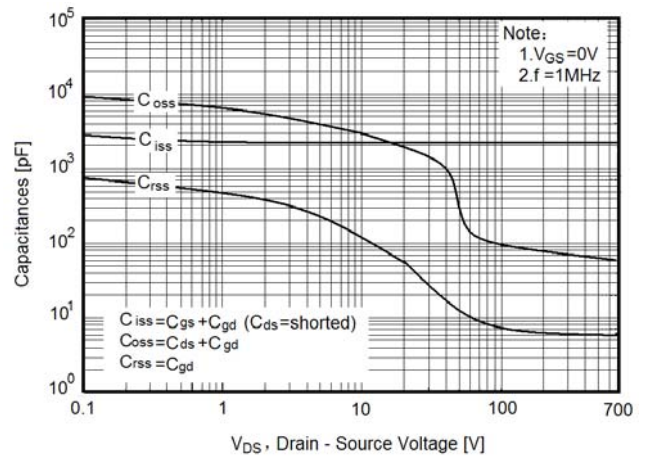
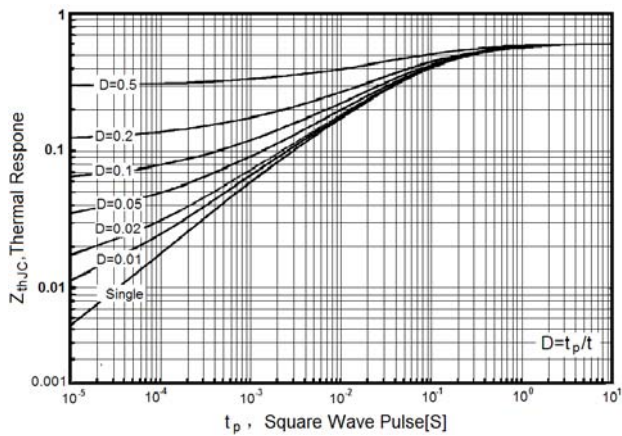
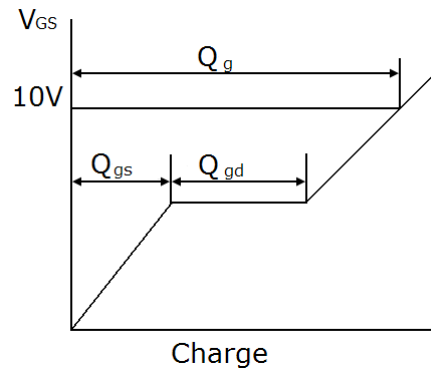
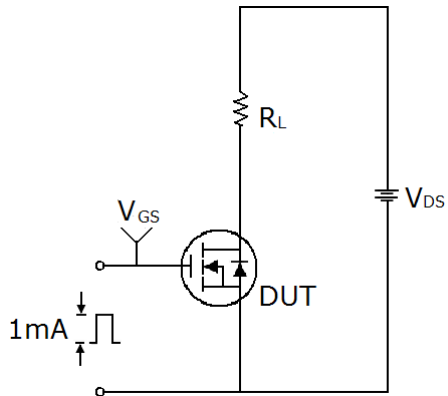


Figure11. Transient Thermal Impedance

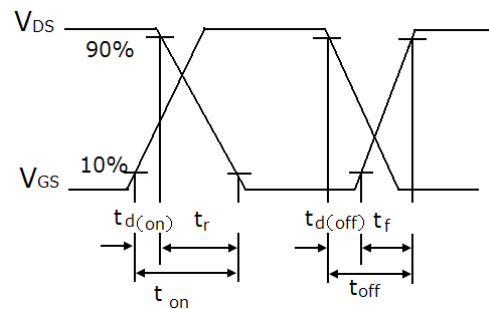
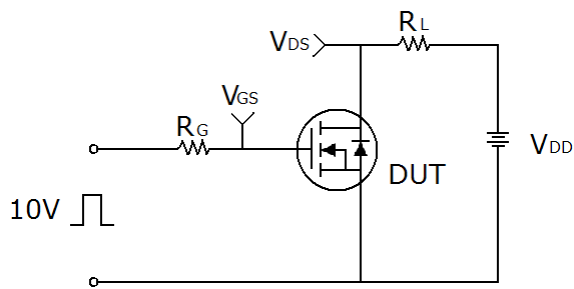


Test circuit

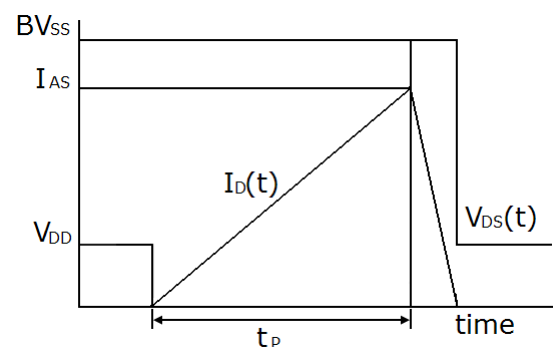
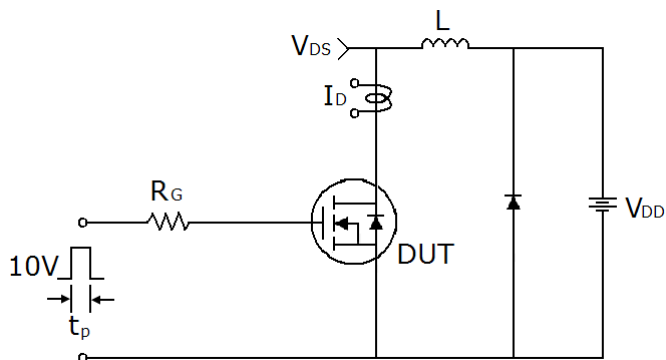
1) Gate charge test circuit & Waveform



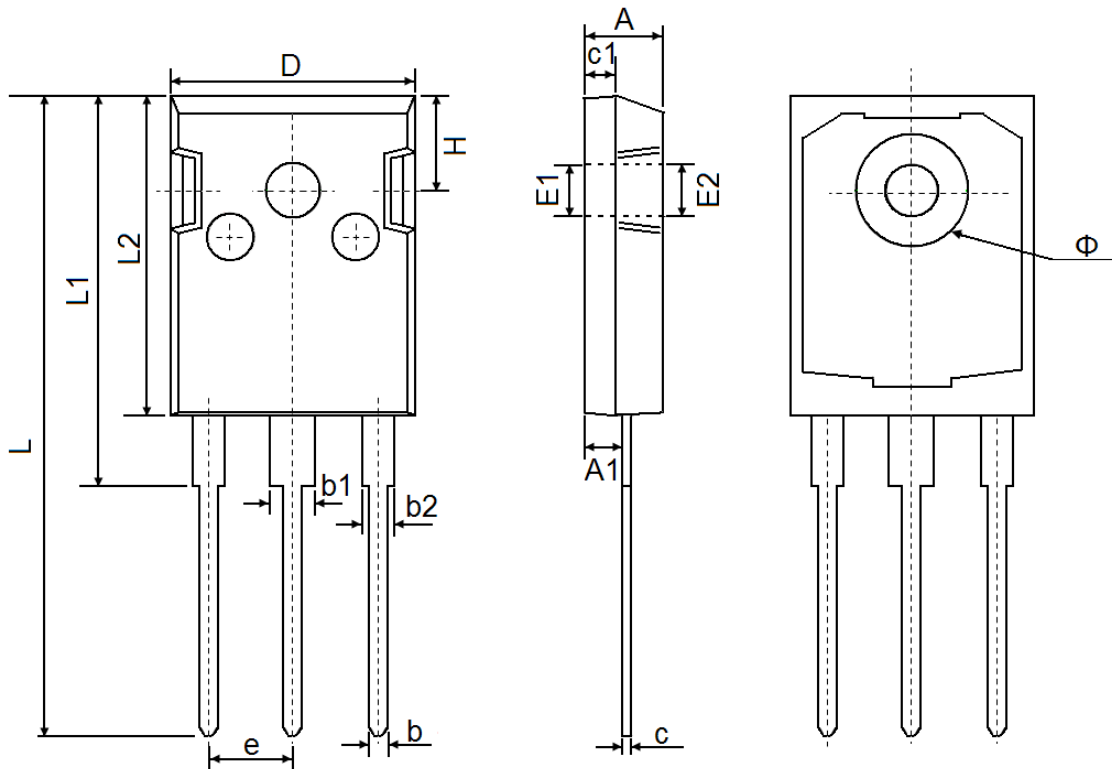
2) Switch Time Test Circuit:



3) Unclamped Inductive Switching Test Circuit & Waveforms



TO-247 Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	4.850	5.150	0.191	0.200
A1	2.200	2.600	0.087	0.102
b	1.000	1.400	0.039	0.055
b1	2.800	3.200	0.110	0.126
b2	1.800	2.200	0.071	0.087
c	0.500	0.700	0.020	0.028
c1	1.900	2.100	0.075	0.083
D	15.450	15.750	0.608	0.620
E1	3.500 REF		0.138 REF	
E2	3.600 REF		0.142 REF	
L	40.900	41.300	1.610	1.626
L1	24.800	25.100	0.976	0.988
L2	20.300	20.600	0.799	0.811
Φ	7.100	7.300	0.280	0.287
e	5.450 TYP		0.215 TYP	
H	5.980 REF		0.235 REF	

ATTENTION:

- Any and all NCE products described or contained herein do not have specifications that can handle applications that require extremely high levels of reliability, such as life-support systems, aircraft's control systems, or other applications whose failure can be reasonably expected to result in serious physical and/or material damage. Consult with your NCE representative nearest you before using any NCE products described or contained herein in such applications.
- NCE assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all NCE products described or contained herein.
- Specifications of any and all NCE products described or contained herein stipulate the performance, characteristics, and functions of the described products in the independent state, and are not guarantees of the performance, characteristics, and functions of the described products as mounted in the customer's products or equipment. To verify symptoms and states that cannot be evaluated in an independent device, the customer should always evaluate and test devices mounted in the customer's products or equipment.
- NCE Power Semiconductor CO.,LTD. strives to supply high-quality high-reliability products. However, any and all semiconductor products fail with some probability. It is possible that these probabilistic failures could give rise to accidents or events that could endanger human lives, that could give rise to smoke or fire, or that could cause damage to other property. When designing equipment, adopt safety measures so that these kinds of accidents or events cannot occur. Such measures include but are not limited to protective circuits and error prevention circuits for safe design, redundant design, and structural design.
- In the event that any or all NCE products(including technical data, services) described or contained herein are controlled under any of applicable local export control laws and regulations, such products must not be exported without obtaining the export license from the authorities concerned in accordance with the above law.
- No part of this publication may be reproduced or transmitted in any form or by any means, electronic or mechanical, including photocopying and recording, or any information storage or retrieval system, or otherwise, without the prior written permission of NCE Power Semiconductor CO.,LTD.
- Information (including circuit diagrams and circuit parameters) herein is for example only ; it is not guaranteed for volume production. NCE believes information herein is accurate and reliable, but no guarantees are made or implied regarding its use or any infringements of intellectual property rights or other rights of third parties.
- Any and all information described or contained herein are subject to change without notice due to product/technology improvement, etc. When designing equipment, refer to the "Delivery Specification" for the NCE product that you intend to use.
- This catalog provides information as of Mar. 2010. Specifications and information herein are subject to change without notice.